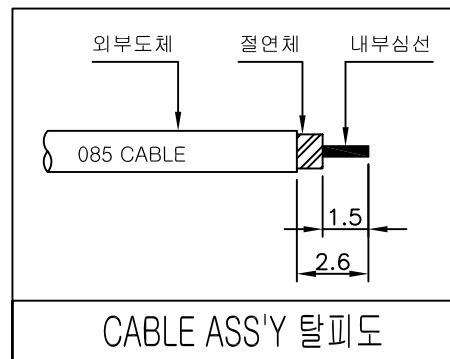
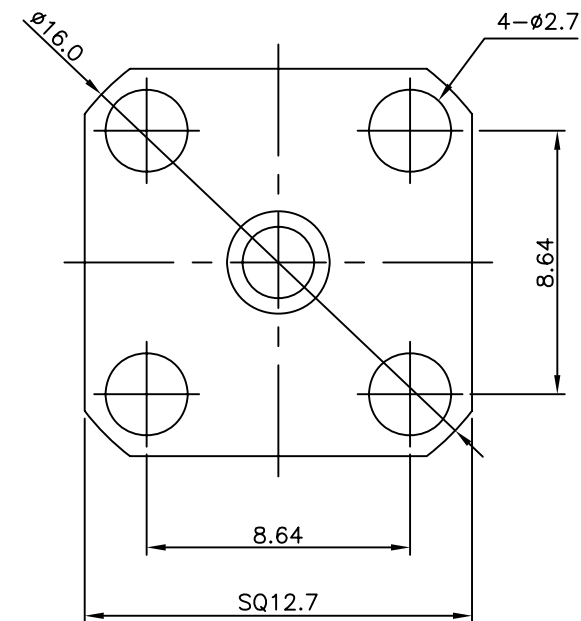
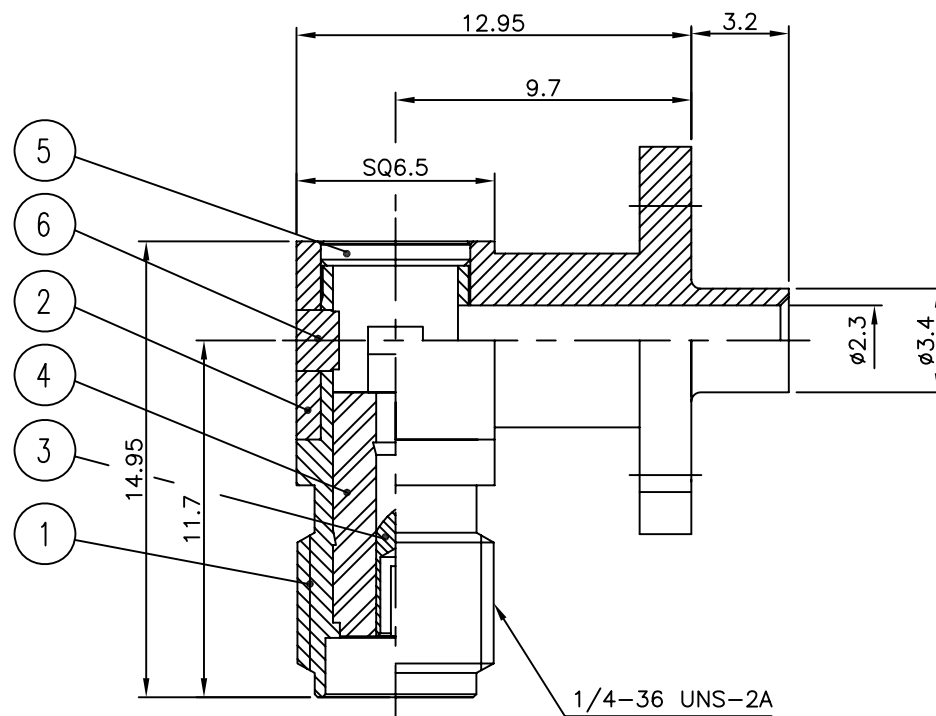


REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	S.Y.EUN	I.C.KIM	2019.04.29



- * 조립 시 참고사항
- BODY (A) Hole 작은 쪽 → KEY 조립부
- * BODY A=B 조립 JIG
- 하JIG : DEQ00538-1/2

6	KEY	1	MBsBD C3604BD-F	Gold Plate	DKY00029-5/1
5	COVER	1	MBsBD C3604BD-F	Gold Plate	DCO00023-5/1
4	INSULATOR	1	TEFLON		DIN02468-N/1
3	CONTACT	1	BeCu C17300	Gold Plate	DCT04007-5/1
2	BODY (B)	1	MBsBD C3604BD-F	Gold Plate	DBD04483-5/1
1	BODY (A)	1	MBsBD C3604BD-F	Gold Plate	DBD04482-5/1
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal	DATE			 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017			
	± 0.1	2019. 04. 29.						
	Angle	APPROVED BY	I.C.KIM					
MATERIAL	$\pm 1^{\circ}$	CHECKED BY	TITLE			SMA50 CABLE JL-4H 85F		
	-	DRAWN BY						
FINISH	-	SCALE	UNIT		A4	DWG NO. CN01236-7/2		
	-	4/1	mm			REVISION	I R	SHEET